



JTW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : In-De OU et al. Confirmation No: 4280
Appl. No. : 10/627,609
Filed : July 28, 2003
Title : CIRCUIT SUBSTRATE AND FABRICATION METHOD
THEREOF

TC/A.U. : 2818
Examiner : P. T. Dang

Docket No.: : OUIIN3001/REF
Customer No: : 23364

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action of January 31, 2005, in connection with the above-identified application. This response is timely filed.

Please amend the application as follows:

Amendments to the specification begin on page 2 of this paper.

Amendments to the drawings begin on page 3 of this paper.

Amendments to the claims are reflected in the listing of claims which begins on page 4 of this paper.

Remarks begin on page 8 of this paper.